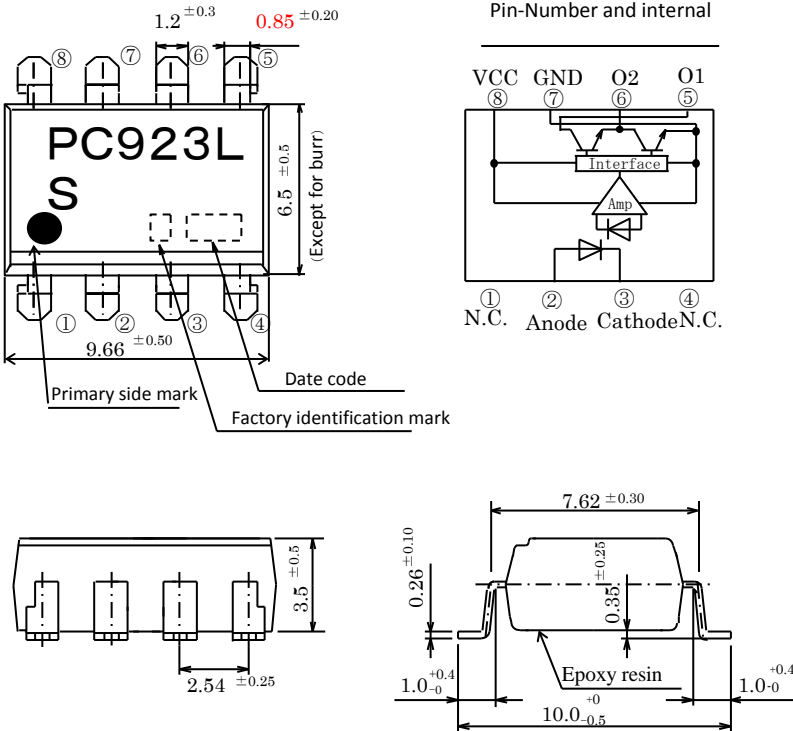
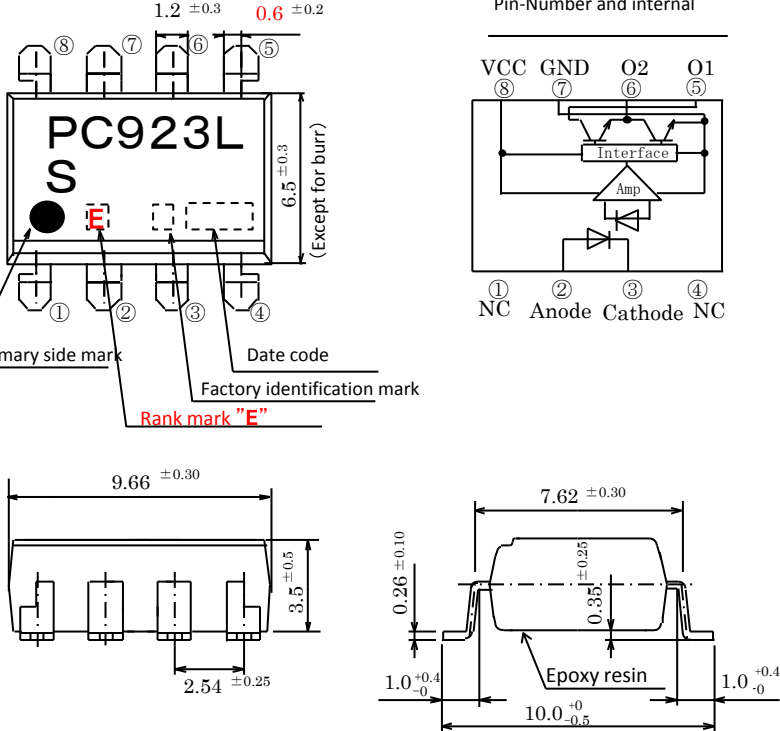


PC923L0NIP0F – PC923LENIP0F Comparison table

January 16, 2012

Business dealing name	PC923L0NIP0F	PC923LENIP0F
Outline dimensions	 <p>Technical drawing of PC923L0NIP0F showing top and side views with dimensions and internal circuit diagram. Dimensions include: 1.2 ±0.3, 0.85 ±0.20, 6.5 ±0.5 (Except for burr), 9.66 ±0.50, 3.5 ±0.5, 2.54 ±0.25, 7.62 ±0.30, 0.26 ±0.10, 10.0⁺⁰_{-0.5}, 1.0^{+0.4}₋₀, 0.35 ±0.25, 1.0 ±0.4. Internal circuit diagram shows VCC (8), GND (7), O2 (6), O1 (5) and ① N.C., ② Anode, ③ Cathode, ④ N.C. Labels include Primary side mark, Date code, and Factory identification mark.</p>	 <p>Technical drawing of PC923LENIP0F showing top and side views with dimensions and internal circuit diagram. Dimensions include: 1.2 ±0.3, 0.6 ±0.2, 6.5 ±0.3 (Except for burr), 9.66 ±0.30, 3.5 ±0.5, 2.54 ±0.25, 7.62 ±0.30, 0.26 ±0.10, 10.0⁺⁰_{-0.5}, 1.0^{+0.4}₋₀, 0.35 ±0.25, 1.0 ±0.4. Internal circuit diagram shows VCC (8), GND (7), O2 (6), O1 (5) and ① NC, ② Anode, ③ Cathode, ④ NC. Labels include Primary side mark, Date code, Factory identification mark, and Rank mark "E".</p>
Mark	Laser mark (Refer to the outline dimensions)	Laser mark (Refer to the outline dimensions)
Infrared Light Emitting Diode Chip	Same	
Light sensitive IC Chip	Same	
Lead Frame material	Pin material : Copper Alloy Pin finish : SnCu plating	Pin material : Copper Alloy Pin finish : Palladium (Au flash plating)
Factory	Same	
Packing	Same	
Characteristics	Same	